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April 1st, 2010
Renesas Electronics Corporation

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M16C/80, M32C/83 Group

Differences between M16C/80 and M32C/83

1. Abstract

This issue is the reference materials of function differences between M16C/80 and M32C/83.

2. Introduction

The explanation of this issue is applied to the following condition:

Applicable MCU: M16C/80, M32C/83 Group

3. Contents

3.1 Function Differences

Table 3.1.1 and table 3.1.2 show the Function Differences.

Table 3.1.1 Function Differences (1) (Note1)

Item	M16C/80	M32C/83
Basic Instructions	106 instructions	108 instructions (Add SHANC, SHLNC instructions)
Shortest Instruction Execution Time	50ns($f(X_{IN})=20\text{MHz}$)	31.3ns($f(\text{BCLK})=32\text{MHz}$)
Supply Voltage	4.2V to 5.5V($f(X_{IN})=20\text{MHz}$) 2.7V to 5.5V($f(X_{IN})=10\text{MHz}$)	4.2V to 5.5V ($f(\text{BCLK})=32\text{MHz}$, through VDC) 3.0V to 5.5V ($f(\text{BCLK})=20\text{MHz}$, through VDC) 3.0V to 3.6V ($f(\text{BCLK})=20\text{MHz}$, not through VDC)
Clock Generating Circuit	XIN, XCIN	XIN, XCIN, PLL, On-chip oscillator
Main clock, sub clock drive capability select function	Have	None
Peripheral Function clock	f1, f8, f32, fc32	f1, f8, fc32, f2n (n=0 to 15. No division when n=0)
Oscillation Stop Detect Function	None	Have
Power Consumption	45mA(5V, $f(X_{IN})=20\text{MHz}$)	41mA (VCC=5V, $f(\text{BCLK})=32\text{MHz}$) 38mA (VCC=5V, $f(\text{BCLK})=30\text{MHz}$) 26mA (VCC=3.3V, $f(\text{BCLK})=20\text{MHz}$) 470μA (VCC=5V, $f(\text{XCIN})=32\text{kHz}$, in wait mode) 340μA (VCC=3.3V, $f(\text{XCIN})=32\text{kHz}$, through VDC in wait mode) 5.0μA (VCC=3.3V, $f(\text{XCIN})=32\text{kHz}$, not through VDC in wait mode) 0.4μA (VCC=5V, in stop mode) 0.4μA (VCC=3.3V, in stop mode)
Access to SFR	1 wait fixed	Variable (1 to 2 waits)
Protect	Can be set for PM0, PM1, CM0, CM1, MCD, PD9, PS3 register	Can be set for PM0, PM1, CM0, CM1, MCD, PD9, PS3, CM2, PLC0, PLC1, INVC0, INVC1, PLV, VDC0 register
DMA Request Factors	Falling edge or both edges of input signals to the INT0 to INT3 pin Timer A0 to timer A4 interrupt requests Timer B0 to timer B5 interrupt requests UART0 to UART4 transmit and receive interrupt requests A/D conversion interrupt request Software trigger	The next interrupt is added to M16C/80. A/D1 conversion interrupt request Intelligent I/O interrupt request CAN interrupt request
DMAII Function	None	Have
Timer A, Timer B Count Source	Selectable: f1, f8, f32, fc32	Selectable: f1, f8, fc32, f2n(n=0 to 15,.No division when n=0)

Note 1: About the details and the characteristics, refer to hardware manual.

Table 3.1.2 Function Differences (2) (Note1)

Item	M16C/80	M32C/83
Three-Phase Motor Control Timer Dead Time	Have	Selectable
Three-Phase Motor Control Timer Dead Time Trigger	Fixed	Selectable
Three-Phase Motor Control Timer Count Source	Selectable: f ₁ , f ₈ , f ₃₂ , f _{c32}	Selectable: f ₁ , f ₈ , f _{c32} , f _{2n} (n=0 to 15. No division when n=0)
Serial I/O	(Clock synchronous serial I/O, Clock asynchronous serial I/O) × 2 (Clock synchronous serial I/O, Clock asynchronous serial I/O, I ² C bus™ (Note 2), IEBus™ (Note 3), SIM interface) × 3	(Clock synchronous serial I/O, Clock asynchronous serial I/O, I ² C bus™ (Note 2), IEBus™ (Note 3), GCI bus, SIM interface) × 5
Serial I/O CTS/RTS Separate Function	Can be used in UART0	None
Serial I/O Transfer Clock Output from Multiple Pins	Can be used in UART1	None
Serial I/O Tx/D, Rx/D I/O Polarity Switching Function	Can be used in UART2 to UART4	Can be used in UART0 to UART4
Serial I/O Sleep Function	Can be used in UART0, UART1	None
Serial I/O Count Source	Selectable: f ₁ , f ₈ , f ₃₂	f ₁ , f ₈ , f _{2n} (n=0 to 15. No division when n=0)
Serial I/O Overrun error occur timing	This error occurs when the next data is ready before contents of UiRB register (i=0 to 4) are read out	This error occurs if the serial I/O started receiving the next data before reading the UiRB register (i=0 to 4) and received the 7th bit of the next data (Clock synchronous serial I/O). This error occurs if the serial I/O started receiving the next data before reading the UiRB register and received the bit one before the last stop bit of the next data (Clock asynchronous serial I/O).
Serial I/O RTS Timing	Assert low when reception is completed	Assert low when receive buffer is read
Serial I/O I ² C Mode	Start condition, stop condition: Not auto-generation	Start condition, stop condition: Auto-generation
Serial I/O I ² C mode SDA delay	SDA digital delay count source: 1/f(XIN)	SDA digital delay count source: BRG
CAN Module	None	1 channel
Intelligent I/O	None	4 group
A/D Converter	1 circuit, 10 channels	2 circuits, 34 channels
A/D Converter Maximum Operating Frequency	10MHz	16MHz (VCC=5.0V)
A/D Converter Operating Clock	Selectable: f _{AD} , f _{AD/2} , f _{AD/4}	Selectable: f _{AD} , f _{AD/2} , f _{AD/3} , f _{AD/4}

Note 1: About the details and the characteristics, refer to hardware manual.

Note 2: I²C bus is a trademark of Koninklijke Philips Electronics N. V.

Note 3: IEBus is a trademark of NEC Electronics Corporation.

3.2 Pin function Differences

Table 3.2.1 and table 3.2.2 show the Pin Function Differences.

Table 3.2.1 Pin Function Differences (1/2)

M16C/80	M32C/83	Remarks
P92/TB2IN/TxD3/SDA3/SRxD3	P92/TB2IN/TxD3/SDA3/SRxD3/IEOUT/ISTxD2/OUTC20	Add IEOUT/ISTxD2/OUTC20
P91/TB1IN/RxD3/SCL3/STxD3	P91/TB1IN/RxD3/SCL3/STxD3/ISRxD2/IEIN	Add ISRxD2/IEIN
P143	P143/INPC17/OUTC17	Add INPC17/OUTC17
P142	P142/INPC16/OUTC16	Add INPC16/OUTC16
P141	P141/OUTC15	Add OUTC15
P140	P140/OUTC14	Add OUTC14
P87/XCIN	P87/XCIN/VCONT	Add VCONT
P83/INT1	P83/INT1/CANIN	Add CANIN
P82/INT0	P82/INT0/OUTC32/CANOUT/ISRxD3	Add OUTC32/CANOUT/ISRxD3
P81/TA4IN/U	P81/TA4IN/U/OUTC30/ISTxD3	Add OUTC30/ISTxD3
P80/TA4OUT/U	P80/TA4OUT/U/INPC02/ISRxD0/BE0IN	Add INPC02/ISRxD0/BE0IN
P77/TA3IN	P77/TA3IN/INPC01/OUTC01/ISCLK0/CANIN	Add INPC01/OUTC01/ISCLK0/CANIN
P76/TA3OUT	P76/TA3OUT/INPC00/OUTC00/ISTxD0/BE0OUT/CANOUT	Add INPC00/OUTC00/ISTxD0/BE0OUT/CANOUT
P75/TA2IN/W	P75/TA2IN/W/INPC12/OUTC12/ISRxD1/BE1IN	Add INPC12/OUTC12/ISRxD1/BE1IN
P74/TA2OUT/W	P74/TA2OUT/W/INPC11/OUTC11/ISCLK1	Add INPC11/OUTC11/ISCLK1
P73/V/CTS2/RTS2/TA1IN	P73/V/CTS2/RTS2/SS2/TA1IN/OUTC10/ISTxD1/BE1OUT	Add OUTC10/ISTxD1/BE1OUT/SS2
P71/RxD2/SCL2/TA1OUT/TB5IN	P71/RxD2/SCL2/TA1OUT/TB5IN/STxD2/OUTPC22/ISRxD2/IEIN	Add STxD2/OUTPC22/ISRxD2/IEIN
P70/TxD2/SDA2/TA0OUT	P70/TxD2/SDA2/TA0OUT/SRxD2/OUTC20/ISTxD2/IEOUT	Add SRxD2/OUTC20/ISTxD2/IEOUT
P67/TxD1	P67/TxD1/SDA1/SRxD1	Add SDA1/SRxD1
P66/RxD1	P66/RxD1/SCL1/STxD1	Add SCL1/STxD1
P64/CTS1/RTS1/CTS0/CLKS1	P64/CTS1/RTS1/SS1/OUTC21/ISCLK2	Add SS1/OUTC21/ISCLK2 Delete CTS0/CLKS1
P63/TxD0	P63/TxD0/SDA0/SRxD0	Add SDA0/SRxD0
P62/RxD0	P62/RxD0/SCL0/STxD0	Add SCL0/STxD0
P60/CTS0/RTS0	P60/CTS0/RTS0/SS0	Add SS0
P137	P137/OUTC27	Add OUTC27
P136	P136/OUTC21/ISCLK2	Add OUTC21/ISCLK2
P135	P135/OUTC22/ISRxD2/IEIN	Add OUTC22/ISRxD2/IEIN
P134	P134/OUTC20/ISTxD2/IEOUT	Add OUTC20/ISTxD2/IEOUT
P133	P133/OUTC23	Add OUTC23
P132	P132/OUTC26	Add OUTC26
P131	P131/OUTC25	Add OUTC25
P130	P130/OUTC24	Add OUTC24
P127	P127/OUTC37	Add OUTC37
P126	P126/OUTC36	Add OUTC36
P125	P125/OUTC35	Add OUTC35
P124	P124/OUTC34	Add OUTC34
P123	P123/OUTC33	Add OUTC33
P122	P122/OUTC32/ISRxD3	Add OUTC32/ISRxD3
P121	P121/OUTC31/ISCLK3	Add OUTC31/ISCLK3
P120	P120/OUTC30/ISTxD3	Add OUTC30/ISTxD3

Table 3.2.2 Pin Function Differences (2/2)

M16C/80	M32C/83	Remarks
P27/A7(/D7)	P27/A7(/D7)/AN27	Add AN27
P26/A6(/D6)	P26/A6(/D6)/AN26	Add AN26
P25/A5(/D5)	P25/A5(/D5)/AN25	Add AN25
P24/A4(/D4)	P24/A4(/D4)/AN24	Add AN24
P23/A3(/D3)	P23/A3(/D3)/AN23	Add AN23
P22/A2(/D2)	P22/A2(/D2)/AN22	Add AN22
P21/A1(/D1)	P21/A1(/D1)/AN21	Add AN21
P20/A0(/D0)	P20/A0(/D0)/AN20	Add AN20
P07/D7	P07/AN07/D7	Add AN07
P06/D6	P06/AN06/D6	Add AN06
P05/D5	P05/AN05/D5	Add AN05
P04/D4	P04/AN04/D4	Add AN04
P113	P113/OUTC13	Add OUTC13
P112	P112/OUTC12/INPC12/ISRxD1/BE1IN	Add OUTC12/INPC12/ISRxD1/BE1IN
P111	P111/OUTC11/INPC11/ISCLK1	Add OUTC11/INPC11/ISCLK1
P110	P110/OUTC10/ISTxD1/BE1OUT	Add OUTC10/ISTxD1/BE1OUT
P03/D3	P03/AN03/D3	Add AN03
P02/D2	P02/AN02/D2	Add AN02
P01/D1	P01/AN01/D1	Add AN01
P00/D0	P00/AN00/D0	Add AN00
P157	P157/AN157/INPC07	Add AN157/INPC07
P156	P156/AN156/INPC06	Add AN156/INPC06
P155	P155/AN155/INPC05/OUTC05	Add AN155/INPC05/OUTC05
P154	P154/AN154/INPC04/OUTC04	Add AN154/INPC04/OUTC04
P153	P153/AN153/INPC03	Add AN153/INPC03
P152	P152/AN152/INPC02/ISRxD0/BE0IN	Add AN152/INPC02/ISRxD0/BE0IN
P151	P151/AN151/INPC01/OUTC01/ISCLK0	Add AN151/INPC01/OUTC01/ISCLK0
P150	P150/AN150/INPC00/OUTC00/ISTxD0/BE0OUT	Add AN150/INPC00/OUTC00/ISTxD0/BE0OUT

3.3 SFR Differences

Table 3.3.1 and table 3.2.3 show the SFR Differences.

Table 3.3.1 SFR Differences (1/3)

M16C/80	M32C/83	Remarks
PM1	PM1	Add bit 3. Change set value of reserved bit.
CM0	CM0	Change function
CM1	CM1	Add bit 7. Change function.
PRCR	PRCR	Add bit 3. Change function.
-	CM2	
-	PLV	
-	VDC0	
-	VDC1	
BCN3IC	BCN0IC/BCN3IC	Shard with BCN0IC register
ADIC	AD0IC	Change register name
-	AD1IC	
BCN4IC	BCN1IC/BCN4IC	Shard with BCN1IC register
RLVL	RLVL	Add bit 5
-	Intelligent I/O, CAN related interrupt control register	
-	Intelligent I/O interrupt request register	
-	Intelligent I/O interrupt enable register	
-	Intelligent I/O, related register	
-	IPS	
-	AD1 related register	
-	CAN related register	
-	U4SMR4	
U4SMR2	U4SMR2	Change function
U4SMR	U4SMR	Add bit 7
U4C0	U4C0	Change function
U4C1	U4C1	Change function
INVC1	INVC1	Add bits 5, 6
IFSR	IFSR	Add bits 6, 7
-	U3SMR4	
U3SMR2	U3SMR2	Change function
U3SMR	U3SMR	Add bit 7
U3C1	U3C1	Change function
-	U2SMR4	
U2SMR3	U2SMR3	Add bits 0 to 4
U2SMR2	U2SMR2	Change function
U2SMR	U2SMR	Add bit 7
U2C1	U2C1	Change function
-	TB2SC	
-	TCSPR	

Table 3.3.2 SFR Differences (2/3)

M16C/80	M32C/83	Remarks
-	U0SMR4	
-	U0SMR3	
-	U0SMR2	
-	U0SMR1	
-	U0SMR	
U0MR	U0MR	Address change from 0360h to 0368h. Change function.
U0BRG	U0BRG	Address change from 0361h to 0369h.
U0TB	U0TB	Address change from 0363h-0362h to 036Bh-036Ah.
U0C0	U0C0	Address change from 0364h to 036Ch
U0C1	U0C1	Address change from 0365h to 036Dh. Add bits 4 to 7.
U0RB	U0RB	Address change from 0367h-0366h to 036Bh-036Ah
-	U1SMR3	
-	U1SMR2	
-	U1SMR	
U1MR	U1MR	Address change from 0368h to 02E8h. Change function.
U1BRG	U1BRG	Address change from 0369h to 02E9h.
U1TB	U1TB	Address change from 036Bh-036Ah to 02EBh-02EAh
U1C0	U1C0	Address change from 036Ch to 02ECh
U1C1	U1C1	Address change from 036Dh to 02EDh. Add bits 4 to 7.
U1RB	U1RB	Address change from 036Fh-036Eh to 02EFh-02EEh
UCON	-	
FMR1	-	
FMR0	FMR0	Address change from 0377h to 0057h
-	PLC0	
-	PLC1	
DM0SL	DM0SL	Change function
DM1SL	DM1SL	Change function
DM2SL	DM2SL	Change function
DM3SL	DM3SL	Change function
AD0	AD00	Change register name
AD1	AD01	Change register name
AD2	AD02	Change register name
AD3	AD03	Change register name
AD4	AD04	Change register name
AD5	AD05	Change register name
AD6	AD06	Change register name
AD7	AD07	Change register name
ADCON2	AD0CON2	Change register name. Add bits 4 to 7.
ADCON0	AD0CON0	Change register name. Change function.
ADCON1	AD0CON1	Change register name. Change function.

Table 3.3.3 SFR Differences (3/3)

M16C/80	M32C/83	Remarks
-	PS8	
-	PS9	
PSC	PSC	Add bits 1 to 4, 6. Change function.
PS0	PS0	Add bits 2, 6. Change function.
PS1	PS1	Add bit 7. Change function.
PSL0	PSL0	Add bits 1, 6. Change function.
PSL1	PSL1	Add bits 1, 5, 6. Change function.
PS2	PS2	Add bit 2. Change function.
PS3	PS3	Change function
PSL2	PSL2	Add bits 1, 2.
PSL3	PSL3	Add bit 2
-	PS5	
-	PS6	
-	PS7	

3.4 Interrupt Vector Differences

Table 3.4.1 shows the Fixed Vector Table Differences. Table 3.4.2 shows the Relocatable Vector Table Differences.

Table 3.4.1 Fixed Vector Table Differences

M16C/80 Interrupt Factor	M32C/83 Interrupt Factor	Remarks
Watchdog Timer	Watchdog Timer Oscillation Stop Detection	Add Watchdog Timer

Table 3.4.2 Relocatable Vector Table Differences

M16C/80 Interrupt Factor	M32C/83 Interrupt Factor	Software Interrupt Number
-	A/D1	7
UART0 transmission	UART0 transmission, NACK	17
UART0 reception	UART0 reception, ACK	18
UART1 transmission	UART1 transmission, NACK	19
UART1 reception	UART1 reception, ACK	20
Bus Conflict Detect, Start Condition Detect, Stop Condition Detect (UART2)	Bus Conflict Detect, Start Condition Detect, Stop Condition Detect, Fault Error (UART2)	39
Bus Conflict Detect, Start Condition Detect, Stop Condition Detect, Fault Error (UART3)	Bus Conflict Detect, Start Condition Detect, Stop Condition Detect, Fault Error (UART3 or UART0)	40
Bus Conflict Detect, Start Condition Detect, Stop Condition Detect, Fault Error (UART4)	Bus Conflict Detect, Start Condition Detect, Stop Condition Detect, Fault Error (UART4 or UART1)	41
-	Intelligent I/O Interrupt 0	44
-	Intelligent I/O Interrupt 1	45
-	Intelligent I/O Interrupt 2	46
-	Intelligent I/O Interrupt 3	47
-	Intelligent I/O Interrupt 4	48
-	Intelligent I/O Interrupt 5	49
-	Intelligent I/O Interrupt 6	50
-	Intelligent I/O Interrupt 7	51
-	Intelligent I/O Interrupt 8	52
-	Intelligent I/O Interrupt 9, CAN0	53
-	Intelligent I/O Interrupt 10, CAN1	54
-	Intelligent I/O Interrupt 11, CAN2	57

3.5 Support Tool Differences

Table 3.5.1 shows the support tool differences.

Table 3.5.1 Support Tool Differences

Tool information	M16C/80 Tool Product	M32C/83 Tool Product (Max.20MHz)	M32C/83 Tool Product (Max.30MHz)
C Compiler	M3T-NC308WA	M3T-NC308WA	M3T-NC308WA
Real-time OS	M3T-MR308	M3T-MR308	M3T-MR308
Simulator Debugger	M3T-PD308SIM	M3T-PD308SIM	M3T-PD308SIM
Emulator Debugger	M3T-PD308	M3T-PD3083	M3T-PD308F
Emulator	PC4701U	PC4701U	PC7501
Emulation Pod, Emulation Probe	M30803T-RPD-E	M30830T-RPD-E	M30830T-EPB

4. Reference

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E-mail: csc@renesas.com

Hardware Manual

M32C/83 Group Hardware Manual

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User's Manual

M16C/80 Group User's Manual

(Use the latest version on the home page: <http://www.renesas.com>)

REVISION HISTORY

Rev.	Date	Description	
		Page	Summary
1.01	2005.01.12	-	First edition issued
1.02	2005.04.15	2	Add A/D converter maximum operating frequency

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